215309-2 ✔ ACTIVE

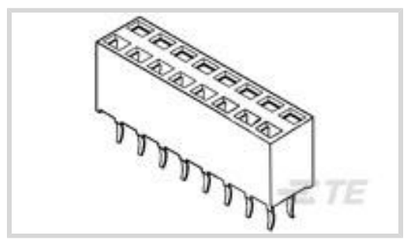
AMPMODU | AMPMODU HV-100/HV-190

TE Internal #: 215309-2

PCB Mount Receptacle, Vertical, Board-to-Board, 4 Position, 2.54 mm [.1 in] Centerline, Gold Flash over Palladium Nickel, AMPMODU HV-100/HV-190

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: **PCB Mount Receptacle**

Connector System: **Board-to-Board**

Number of Positions: **4**

Number of Rows: **2**

Centerline (Pitch): **2.54 mm [.1 in]**

Features

Product Type Features

PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Stackable	Yes
Number of Positions	4
Number of Rows	2
PCB Mount Orientation	Vertical

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Mating Pin Diameter	.63 mm[.024 in]
Mating Square Post Dimension	.63 mm[.024 in]
PCB Contact Termination Area Plating Material Thickness	2.5 µm[98.42 µin]
Contact Shape & Form	Square

Contact Protection Type	Closed Entry Housing
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
	30 µin
Contact Mating Area Plating Material	Gold Flash over Palladium Nickel
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention Type	Retention Solder Tails
PCB Mount Retention	With

Housing Features

Mating Entry Location	Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester GF

Dimensions

Connector Height	8.5 mm[.335 in]
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.6 mm

Usage Conditions

Operating Temperature Range	-65 – 125 °C[-85 – 257 °F][-67 – 221 °F]

Operation/Application

Solder Process Feature	Board Standoff

Industry Standards

UL Flammability Rating	UL 94V-0

Packaging Features

Packaging Quantity	352
Packaging Method	Carton

Product Compliance

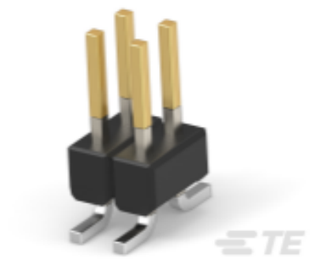
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



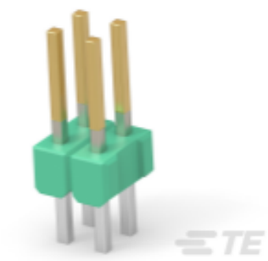
TE Part # 966709-2
2X2P MODUII BREAK AWAY HEADER, SMD



TE Part # 826634-2
2P MOD2 STIFT LEI



TE Part # 826664-2
2P MOD2 STIFT LEI



TE Part # 826632-2
2P AMPMODU II II PIN HDR



TE Part # 826656-2
2P AMPMODU II STIFT LEI

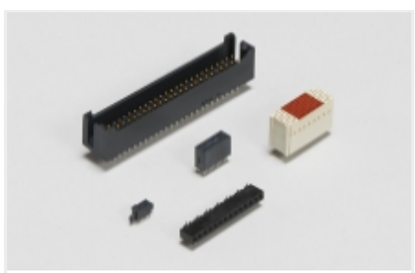


TE Part # 1241050-2
2x2P MOD II BREAK AWAY HDR,SMD, BLISTER

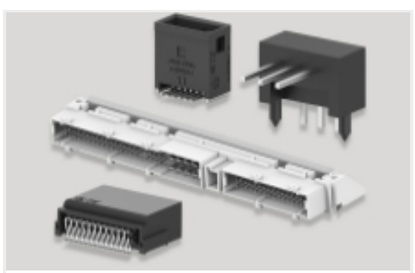


TE Part # 826662-2
2P AMPMODU II STIFT LEI

Also in the Series | AMPMODU HV-100/HV-190



Board-to-Board Headers & Receptacles(152)



PCB Headers & Receptacles(152)

Customers Also Bought



TE Part #951401-000
222D211-12-0



TE Part #1SNG607025R0000
EP-LN-M75-LGR-A



TE Part #1-175218-5
DYNAMIC D-3 REC CONT. L PRE-TIN L/P



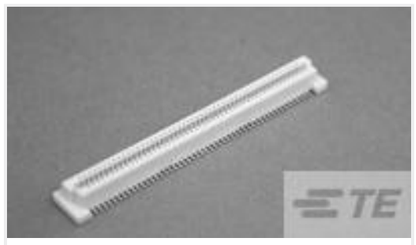
TE Part #1461404-1
OJ-SH-105LM,000



TE Part #2108847-1
Ceramic patch antenna, L1+G1 & L2



TE Part #3-2328724-1
31PIN 0.3MMP FPC CONNECTOR, FRONT FLIP



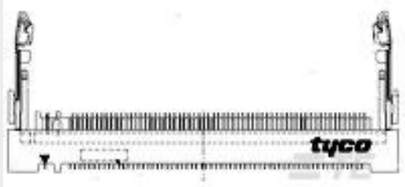
TE Part #1-5177983-2
0.8FH,R05H.5,060,15/Sn,TU



TE Part #1-5177984-0
0.8FH,P05H.5,200,08/Sn,TU



TE Part #5747467-1
HD-20 PLUG 9P RA 590



TE Part #1717831-2
MINI PCI EXPRESS EMBOSS TAPE CONN

Documents

Product Drawings

2X2P HV100 REC CON. TE, 8.5MM

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_215309-2_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_215309-2_F.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_215309-2_F.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.